



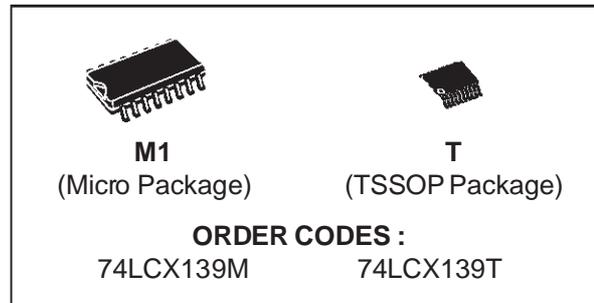
# 74LCX139

## LOW VOLTAGE DUAL 2 TO 4 DECODER/DEMULTIPLEXER

- 5V TOLERANT INPUTS
- HIGH SPEED:  
 $t_{PD} = 6.2 \text{ ns (MAX.) at } V_{CC} = 3\text{V}$
- POWER-DOWN PROTECTION ON INPUTS AND OUTPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OH}| = I_{OL} = 24 \text{ mA (MIN)}$
- PCI BUS LEVELS GUARANTEED AT 24mA
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:  
 $V_{CC} \text{ (OPR)} = 2.0\text{V to } 3.6\text{V (1.5V Data Retention)}$
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 139
- LATCH-UP PERFORMANCE EXCEEDS 500mA
- ESD PERFORMANCE:  
 $\text{HBM} > 2000\text{V}; \text{MM} > 200\text{V}$

### DESCRIPTION

The 74LCX139 is a low voltage CMOS DUAL 2 TO 4 LINE DECODER/ DEMULTIPLEXER fabricated with sub-micron silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology. It is ideal for low power and high speed 3.3V applications; it can be interfaced to 5V signal



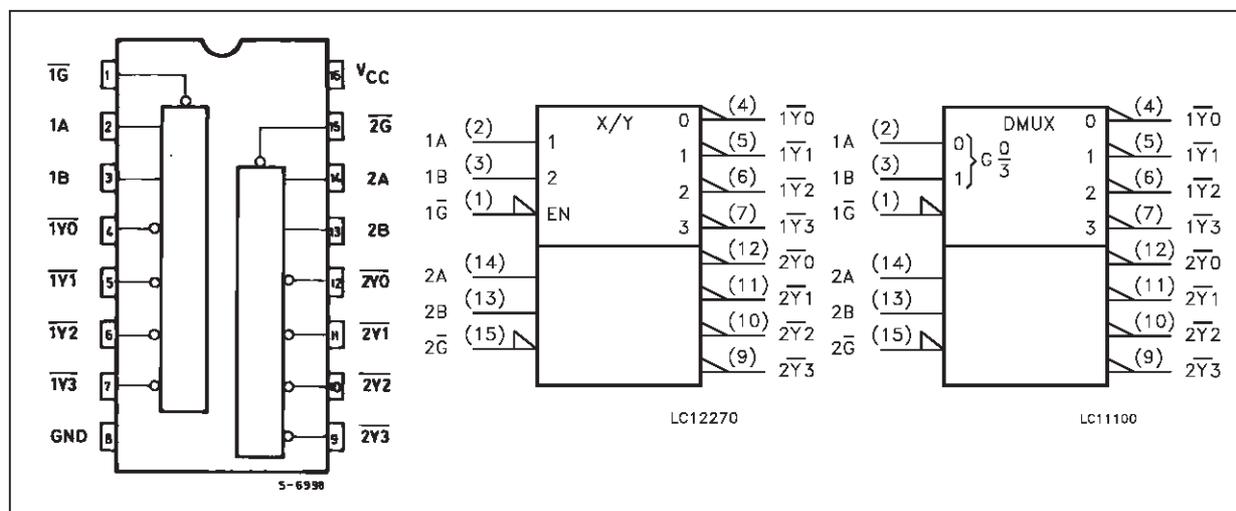
environment for inputs.

The active low enable input can be used for gating or as a data input for demultiplexing applications. While the enable input is held high, all four outputs are high independently of the other inputs.

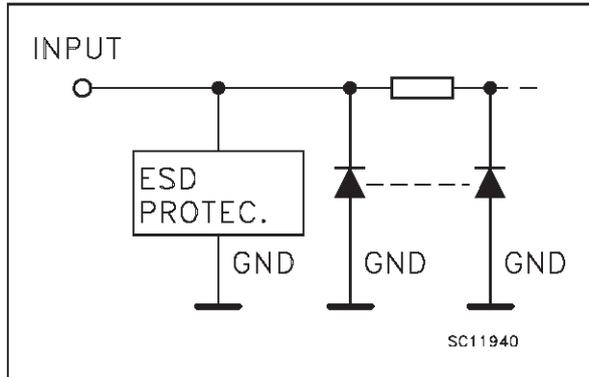
It has same speed performance at 3.3V than 5V AC/ACT family, combined with a lower power consumption.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

### PIN CONNECTION AND IEC LOGIC SYMBOLS



INPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

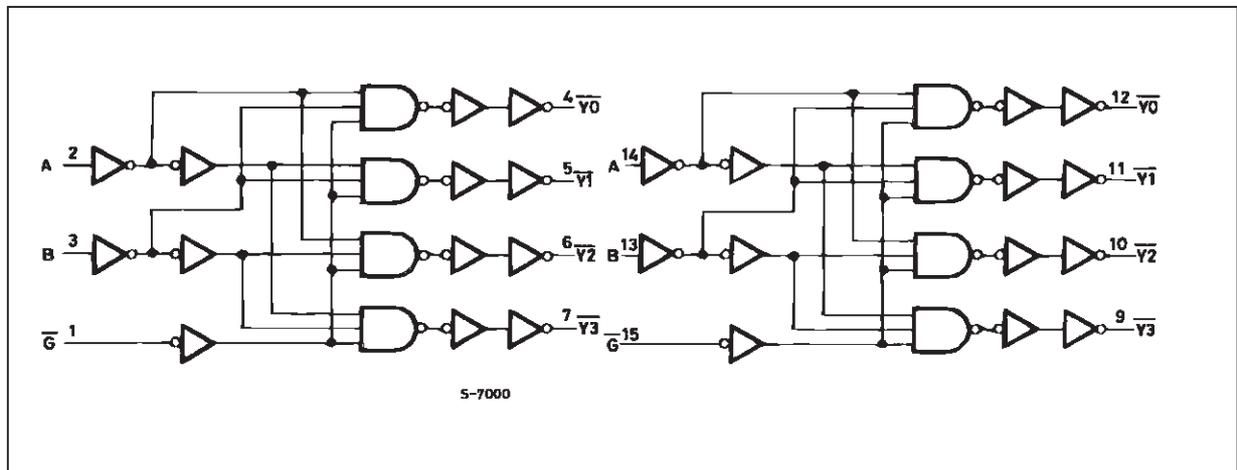
PIN No	SYMBOL	NAME AND FUNCTION
1, 15	$1\overline{G}, 2\overline{G}$	Enable Inputs
2, 3	1A, 1B	Address Inputs
4, 5, 6, 7	$1\overline{Y0}$ to $1\overline{Y3}$	Outputs
12, 11, 10, 9	$2\overline{Y0}$ to $2\overline{Y3}$	Outputs
14, 13	2A, 2B	Address Inputs
8	GND	Ground (0V)
16	V <sub>CC</sub>	Positive Supply Voltage

TRUTH TABLE

INPUTS			OUTPUTS			
ENABLE	SELECT		$\overline{Y0}$	$\overline{Y1}$	$\overline{Y2}$	$\overline{Y3}$
$\overline{G}$	B	A				
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

X: Don't Care

LOGIC DIAGRAM



This logic diagram has not be used to estimate propagation delays

**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to + 7.0	V
V <sub>I</sub>	DC Input Voltage	-0.5 to + 7.0	V
V <sub>O</sub>	DC Output Voltage (V <sub>CC</sub> =0V)	-0.5 to + 7.0	V
V <sub>O</sub>	DC Output Voltage (High or Low State) (note1)	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	- 50	mA
I <sub>OK</sub>	DC Output Diode Current (note2)	± 50	mA
I <sub>O</sub>	DC Output Source/Sink Current	± 50	mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	± 100	mA
I <sub>GND</sub>	DC Ground Current per Supply Pin	± 100	mA
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

1) I<sub>O</sub> absolute maximum rating must be observed

2) V<sub>O</sub> < GND, V<sub>O</sub> > V<sub>CC</sub>

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage (note 1)	2.0 to 3.6	V
V <sub>I</sub>	Input Voltage	0 to 5.5	V
V <sub>O</sub>	Output Voltage (V <sub>CC</sub> =0V)	0 to 5.5	V
V <sub>O</sub>	Output Voltage (High or Low State)	0 to V <sub>CC</sub>	V
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current (V <sub>CC</sub> = 3.0 to 3.6V)	± 24	mA
I <sub>OH</sub> , I <sub>OL</sub>	High or Low Level Output Current (V <sub>CC</sub> = 2.7 to 3.0V)	± 12	mA
T <sub>op</sub>	Operating Temperature:	-40 to +85	°C
dt/dv	Input Transition Rise or Fall Rate (V <sub>CC</sub> = 3.0V) (note 2)	0 to 10	ns/V

1) Truth Table guaranteed: 1.5V to 3.6V

2) V<sub>IN</sub> from 0.8V to 2.0V

## DC SPECIFICATIONS

Symbol	Parameter	Test Conditions		Value		Unit
		V <sub>CC</sub> (V)		-40 to 85 °C		
				Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	2.7 to 3.6		2.0		V
V <sub>IL</sub>	Low Level Input Voltage				0.8	
V <sub>OH</sub>	High Level Output Voltage	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> =-100 μA	V <sub>CC</sub> -0.2	V
		2.7		I <sub>O</sub> =-12 mA	2.2	
		3.0		I <sub>O</sub> =-18 mA	2.4	
				I <sub>O</sub> =-24 mA	2.2	
V <sub>OL</sub>	Low Level Output Voltage	2.7 to 3.6	V <sub>I</sub> = V <sub>IH</sub>	I <sub>O</sub> =100 μA	0.2	V
		2.7		I <sub>O</sub> =12 mA	0.4	
		3.0		I <sub>O</sub> =16 mA	0.4	
		3.0		I <sub>O</sub> =24 mA	0.55	
I <sub>I</sub>	Input Leakage Current	2.7 to 3.6	V <sub>I</sub> = 0 to 5.5 V		±5	μA
I <sub>off</sub>	Power Off Leakage Current	0	V <sub>I</sub> or V <sub>O</sub> = 5.5V		10	μA
I <sub>CC</sub>	Quiescent Supply Current	2.7 to 3.6	V <sub>I</sub> = V <sub>CC</sub> or GND		10	μA
			V <sub>I</sub> or V <sub>O</sub> = 3.6 to 5.5V		±10	
ΔI <sub>CC</sub>	ICC incr. per input	2.7 to 3.6	V <sub>IH</sub> = V <sub>CC</sub> -0.6V		500	μA

AC ELECTRICAL CHARACTERISTICS (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 Ω, Input t<sub>r</sub> = t<sub>f</sub> = 2.5 ns)

Symbol	Parameter	Test Condition		Value		Unit
		V <sub>CC</sub> (V)	Waveform	-40 to 85 °C		
				Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time A, B to $\bar{Y}$	2.7	1		7.3	ns
		3.0 to 3.6		1.0	6.2	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time G to $\bar{Y}$	2.7	2		5.8	ns
		3.0 to 3.6		1.0	5.3	
t <sub>OSLH</sub> t <sub>OSHL</sub>	Output to Output Skew Time (note 1, 2)	3.0 to 3.6			1.0	ns

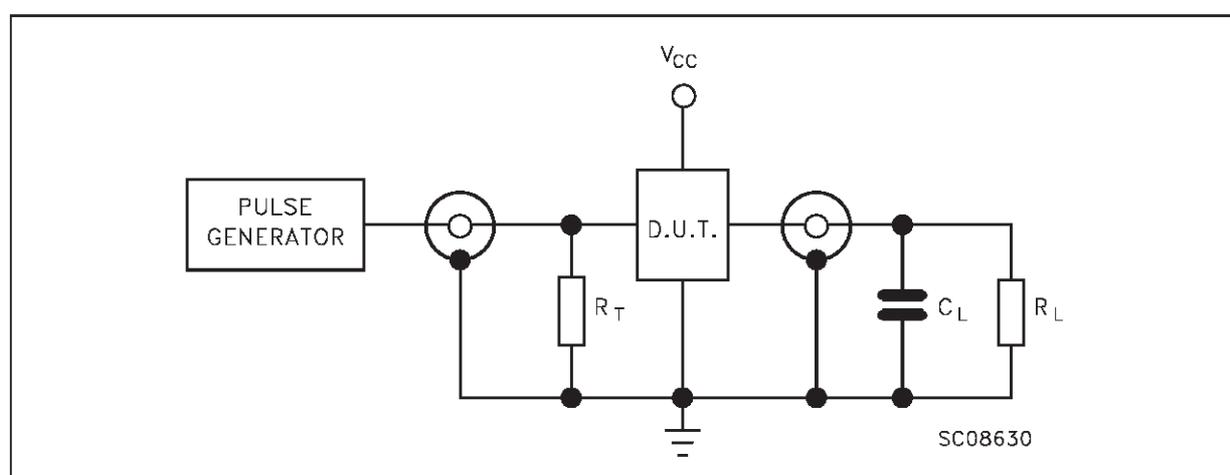
1) Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW (t<sub>OSLH</sub> = |t<sub>PLHm</sub> - t<sub>PLHl</sub>|, t<sub>OSHL</sub> = |t<sub>PHLm</sub> - t<sub>PHLl</sub>|)

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions		Value			Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			
				Min.	Typ.	Max.	
C <sub>IN</sub>	Input Capacitance	3.3	V <sub>IN</sub> = 0 to V <sub>CC</sub>		6		pF
C <sub>PD</sub>	Power Dissipation Capacitance (note 1)	3.3	f <sub>IN</sub> = 10MHz V <sub>IN</sub> = 0 or V <sub>CC</sub>		26		pF

1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the following equation. I<sub>CC(opr)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>IN</sub> + I<sub>CC</sub>/2 (per gate)

## TEST CIRCUIT

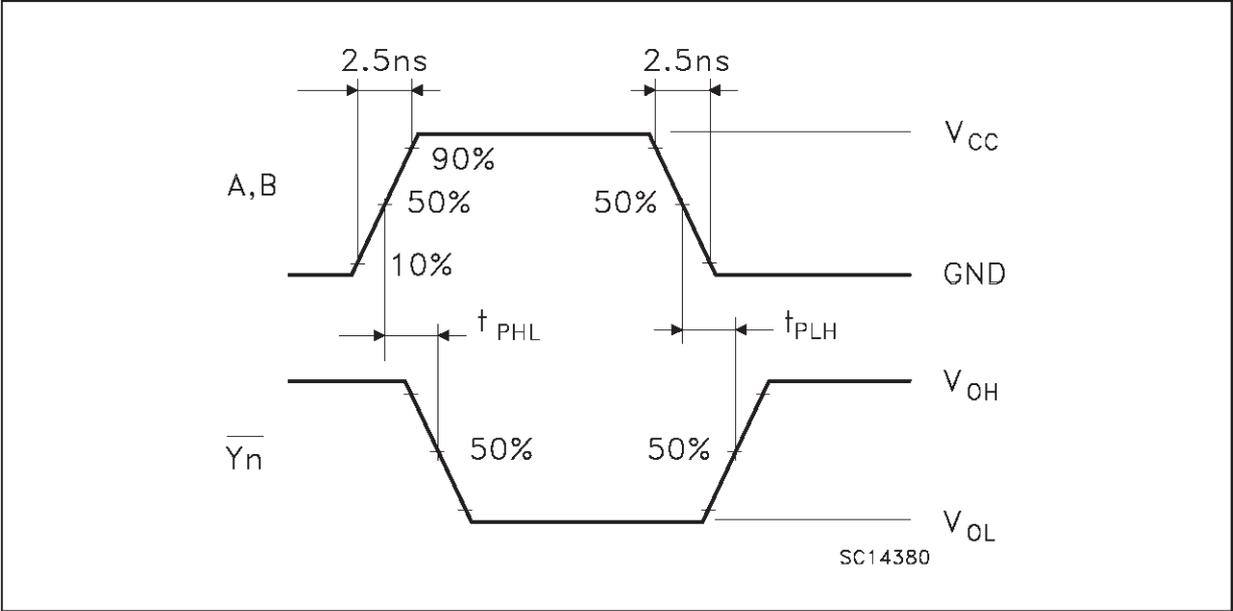


C<sub>L</sub> = 50 pF or equivalent (includes jig and probe capacitance)

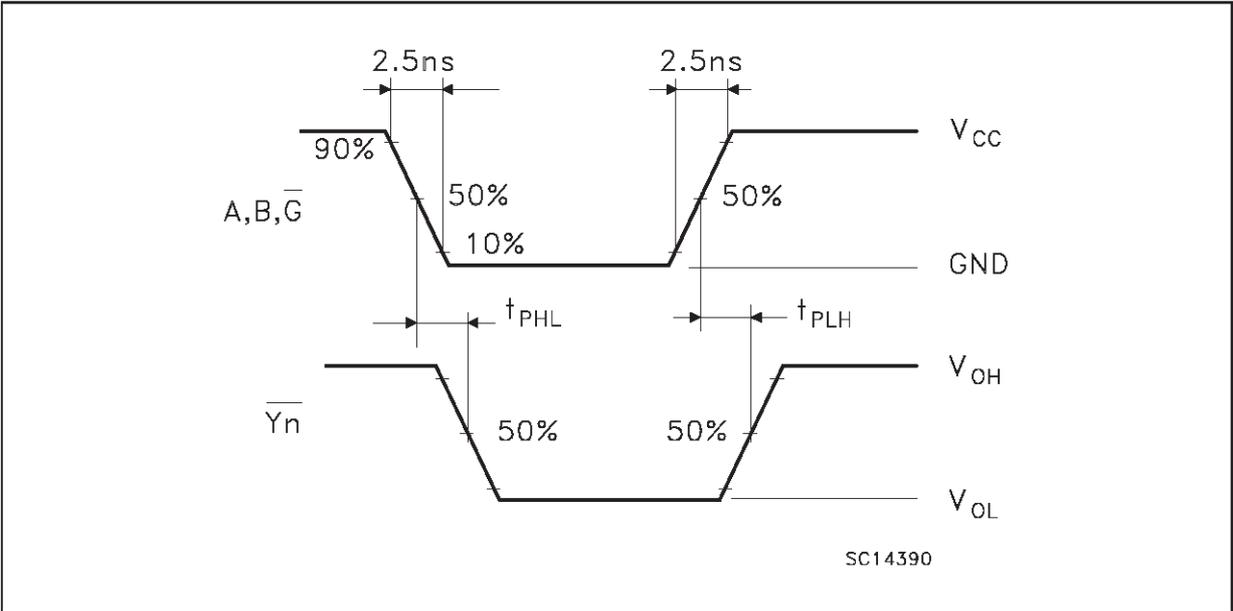
R<sub>L</sub> = 500Ω or equivalent

R<sub>T</sub> = Z<sub>OUT</sub> of pulse generator (typically 50Ω)

WAVEFORM 1: PROPAGATION DELAYS FOR INVERTING OUTPUTS (f=1MHz; 50% duty cycle)

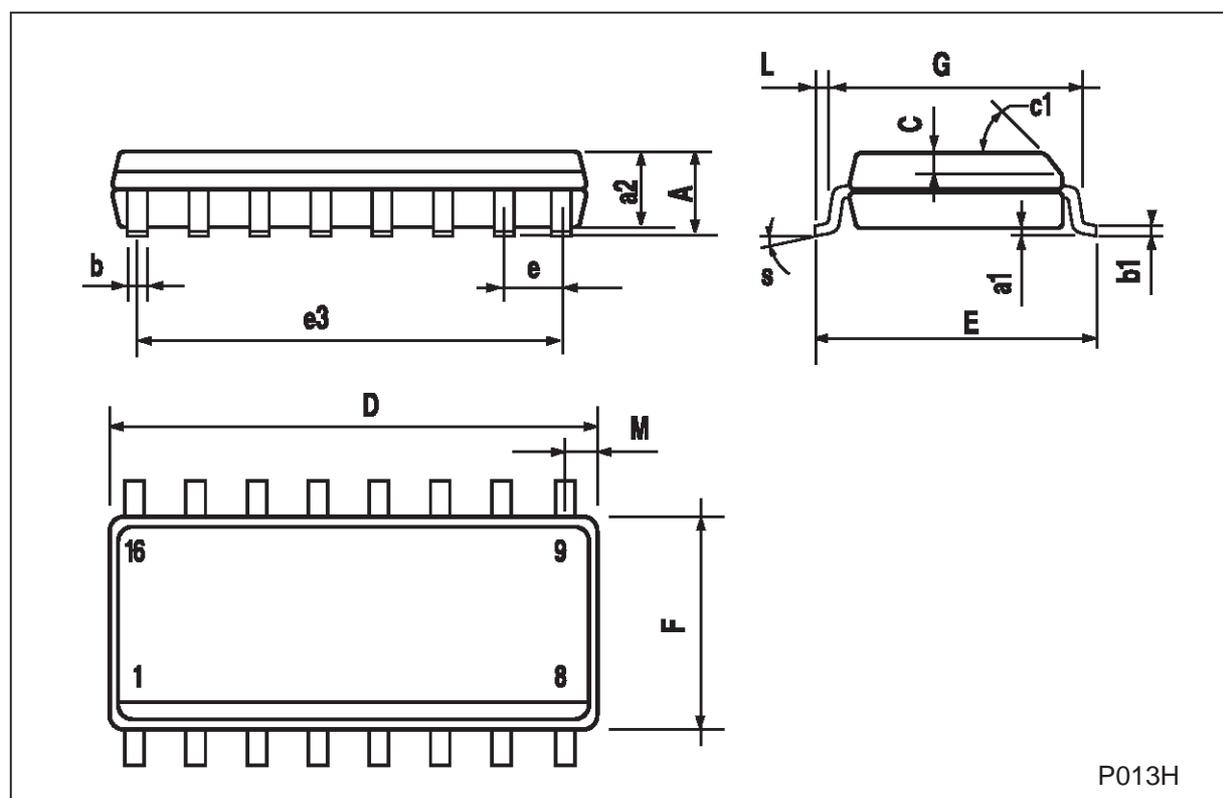


WAVEFORM 2: PROPAGATION DELAYS FOR NON-INVERTING OUTPUTS (f=1MHz; 50% duty cycle)



## SO-16 MECHANICAL DATA

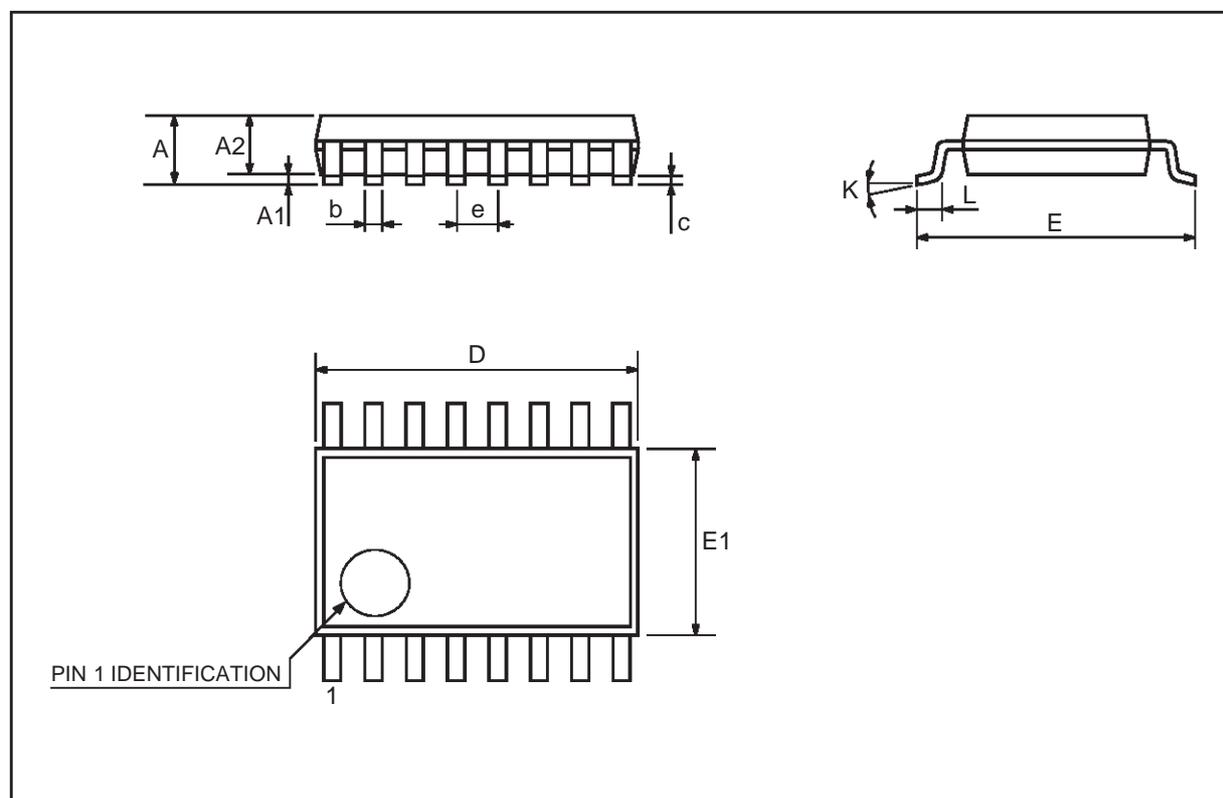
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.004		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45 (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8 (max.)					



P013H

## TSSOP16 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.1			0.433
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.85	0.9	0.95	0.335	0.354	0.374
b	0.19		0.30	0.0075		0.0118
c	0.09		0.20	0.0035		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.25	6.4	6.5	0.246	0.252	0.256
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°	4°	8°	0°	4°	8°
L	0.50	0.60	0.70	0.020	0.024	0.028



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